MGV252012SR47M-10

PHYSICAL DIMENSIONS:

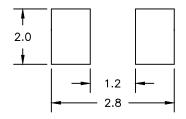
A 2.50 ± 0.20

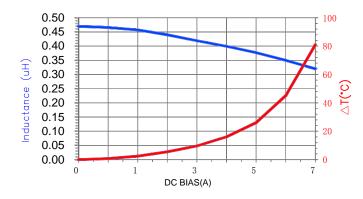
B 2.00 ± 0.20

C 1.20 Max.

 $D = 0.60 \pm 0.30$

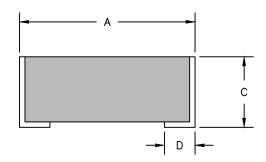
LAND PATTERNS FOR REFLOW SOLDERING



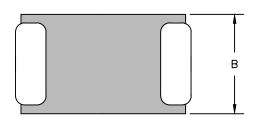


ELECTRICAL SPECIFICATION @ 25°C

	Min	Norm	Max	
INDUCTANCE (uH) L @ 1MHz/1mA ±20%	0.376	0.47	0.564	
DCR (Ω)		0.016	0.022	
Saturation Current Isat (A)		6.80	6.20	
Heating Current Irms (A)		5.80	4.90	







NOTES:

- 1. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. OPERATING TEMPERATURE RANGE: -40° C $\sim +125^{\circ}$ C.
- 4. STORAGE TEMPERATURE RANGE: -50°C ~ +125°C .
- 5. ISat MEANS THAT MAX DC CURRENT WILL CAUSE A PROXIMATELY 30% INDUCTANCE REDUCTION FROM INITIAL VALUE.
- 6. Irms MEANS THAT MAX DC CURRENT WILL CAUSE PROXIMATELY 40°C TEMPERATURE RISE FROM 25±5°C AMBIENT.

	DIMENSIONS ARE IN mm.			This print is the property of Lair Tech. and is loaned in confidence subject to return upon request a	:			
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				PROJECT/PART NUMBER:	REV	PART T	ME:	DRAWN BY:
				MGV252012SR47M-10) 4		WER ICTOR	QIU
				06 /08 /1 /	CALE:	NTS	SHEET:	
Α	ORIGINAL DRAFT	06/08/17	QIU		00L#		1 1	of 1
REV	DESCRIPTION	DATE	INT	MGV252012SR47M-10-A	#	-		01 1